

Summary of HPMS Releases
For the week ending February 8, 2008

Title: Contract Year 2009 Plan Benefit Package/Summary of Benefits Beta Testing
Date: 2/4/08

Summary: We are now conducting beta testing to ensure that all aspects of the CY 2009 PBP software work as designed, including the generation of the SB sentences. As with past years, we are requesting plan assistance in the final testing of the 2009 PBP/SB.

Testing will take place from Monday, February 4, 2008 through Friday, February 15, 2008.

Title: Conference – Medicare Advantage and Prescription Drug Enrollment and Payment – SAVE THE DATE

Date: 2/4/08

Summary: This memo announces the April conference being held by CMS and the Coalition of Enrollment and Reconciliation Vendors.

Title: Enrollment and Disenrollment Audit Periods

Date: 2/4/08

Summary: The Plan Oversight and Accountability Group recently released several revised audit guides and worksheets to reflect changes to the Part C and D Enrollment and Disenrollment process, as well as changes in timelines requirements for enrollee notices.

Title: Verification of Pharmacy Call Center Phone Number in HPMS

Date: 2/5/08

Summary: Currently, the Centers for Medicare and Medicaid Services (CMS), assisted by Research Triangle Institute (RTI) International, is conducting surveillance of Part D Sponsors' beneficiary call center phone lines. Starting in mid-February, CMS will begin surveillance of Sponsors' pharmacy technical help desk phone lines. To prepare for this surveillance, Part D Sponsors should immediately verify that their 2008 pharmacy call center phone numbers, as posted in the Health Plan Management System (HPMS), are current and accurate.

Title: Methodology for Using Various CMS Low Income Subsidy (LIS) Data Sources

Date: 2/5/08

Summary: The purpose of this memo is to provide direction on the hierarchy of LIS data CMS currently transmits or makes available to assist Part D plans. In addition, it describes the first steps of a longer-term approach to improving data-sharing around LIS eligibility information.